BB208-02; BB208-03

Low voltage variable capacitance diode

Rev. 2 — 8 September 2011

Product data sheet

1. Product profile

1.1 General description

The BB208-02 is a planar technology variable capacitance diode in a SOD523 (SC-79) ultra small SMD plastic package.

The BB208-03 is a planar technology variable capacitance diode in a SOD323 (SC-76) very small SMD plastic package.

1.2 Features and benefits

- Very small SMD plastic packages
- Very low series resistance
- Excellent CV linearity
- C_{d(1V)}: 21.5 pF; C_{d(7.5V)}: 4.9 pF
- High ratio.

1.3 Applications

- Voltage Controlled Oscillators (VCO)
- Voltage Controlled Crystal Oscillators/Temperature Controlled Crystal Oscillators (VCXO/TCXO).

2. Pinning information

Table 1. Discrete pinning: SOD523

Pin	Description	Simplified outline	Symbol
1	cathode		Ш
2	anode	1 2	- -
			sym008

Table 2. Discrete pinning: SOD323

Pin	Description	Simplified outline	Symbol
1	cathode		и
2	anode	1 2	+
			sym008



3. Ordering information

Table 3. Ordering information

Type number	Package	Package			
	Name	Description	Version		
BB208-02	' <u>-</u>	plastic surface mounted package; 2 leads	SOD523		
BB208-03	-	plastic surface mounted package; 2 leads	SOD323		

4. Marking

Table 4. Marking

Type number	Marking code
BB208-02	A1
BB208-03	A2

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_R	continuous reverse voltage		-	10	V
I _F	continuous forward current		-	20	mA
T _{stg}	storage temperature		-55	+150	°C
Tj	operating junction temperature		-55	+125	°C

6. Characteristics

Table 6. Electrical characteristics

 $T_i = 25$ °C unless otherwise specified.

,						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _R reve	reverse current	V _R = 10 V; see <u>Figure 2</u>	-	-	10	nA
		$V_R = 10 \text{ V}; T_j = 85 ^{\circ}\text{C}; \text{ see } \frac{\text{Figure 2}}{}$	-	-	200	nA
r _s	diode series resistance	f = 100 MHz; V _R = 3 V	-	0.35	0.5	Ω
C _d	diode capacitance	f = 1 MHz; see Figure 1 and Figure 3				
		V _R = 1 V	19.9	-	23.2	pF
		$V_R = 4 V$	-	10.1	-	pF
		V _R = 7.5 V	4.5	-	5.4	pF
$\frac{C_{d(1V)}}{C_{d(4V)}}$	capacitance ratio	f = 1 MHz	2.0	-	-	
$\frac{C_{d(1V)}}{C_{d(7.5V)}}$	capacitance ratio	f = 1 MHz	3.7	-	5.2	

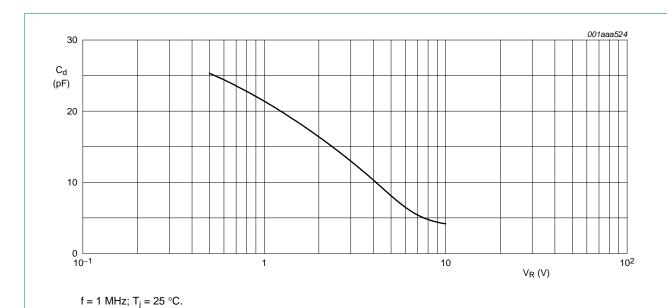


Fig 1. Diode capacitance as a function of reverse voltage; typical values.

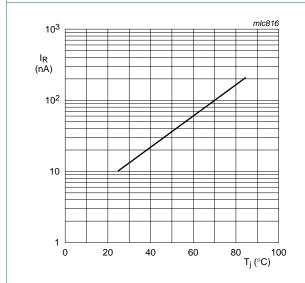


Fig 2. Reverse current as a function of junction temperature; typical values.

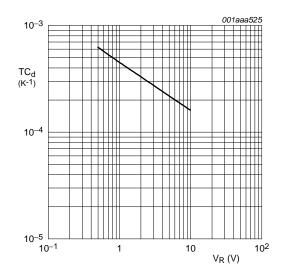


Fig 3. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values.

7. Package outline

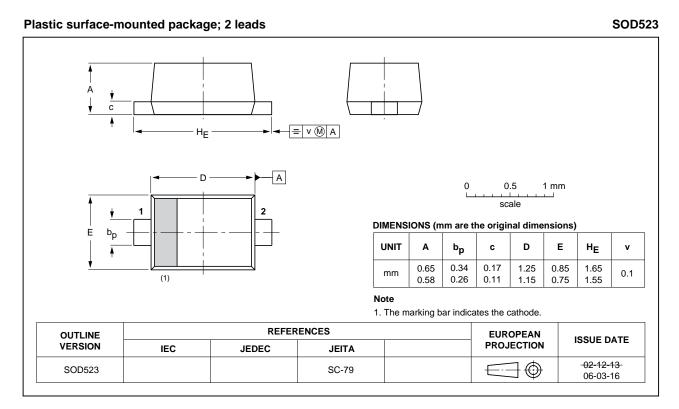


Fig 4. Package outline (BB208-02).

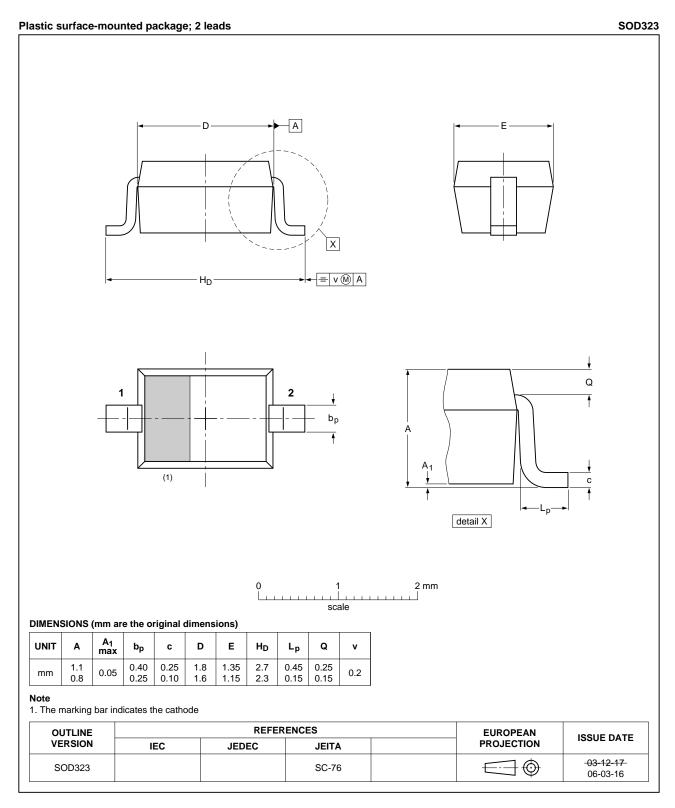


Fig 5. Package outline (BB208-03).

8. Revision history

Table 7. Revision history

Document ID	Release date Data sheet status		Change notice	Supersedes
BB208-02_BB208-03 v.2	20110908	Product data sheet	-	BB208-02_BB208-03 v.1
guidelines of ● Legal texts h		f this data sheet has been red NXP Semiconductors. ave been adapted to the new line drawings have been update	company name whe	re appropriate.
BB208-02_BB208-03 v.1 (9397 750 12696)	20040407	Product data	-	-

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9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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11. Contents

1	Product profile
1.1	General description
1.2	Features and benefits
1.3	Applications 1
2	Pinning information 1
3	Ordering information 2
4	Marking 2
5	Limiting values 2
6	Characteristics 2
7	Package outline
8	Revision history 6
9	Legal information 7
9.1	Data sheet status
9.2	Definitions 7
9.3	Disclaimers
9.4	Trademarks 8
10	Contact information 8
11	Contents

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